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102777066

To the Honorable Commissioner of Patents at _____ ed original documents or copy thereof.

1. Name of conveying party(ies):
Maksim Kuzmenka
Oliver Kiehl
6-2104
Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):
Name: **Infineon Technologies AG**
Address: **St. Martin Str. 53**
City: **Munich** State/Prov.: _____
Country: **Germany** ZIP: **81669**
Additional name(s) & address(es) Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
Execution Date: **5/19/04 and 5/20/04**

4. Application number(s) or patent numbers(s):
If this document is being filed together with a new application, the execution date of the application is: _____
Patent Application No. Filing date
10/759,103 **1/20/04**
Additional numbers Yes No

B. Patent No.(s)
 Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: **Michael A. Oblon**
Registration No. **42,956**
Address: **Shaw Pittman LLP**
1650 Tysons Boulevard
City: **McLean** State/Prov.: **VA**
Country: **USA** ZIP: **22102**

6. Total number of applications and patents involved: **1**
7. Total fee (37 CFR 3.41):.....\$ **40.00**
 Enclosed - Any excess or insufficiency should be credited or debited to deposit account
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8. Deposit account number:
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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Michael A. Oblon *[Signature]* **June 21, 2004**
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and

3

6/21/2004 LIMELETT 0000067 102777066 40.00 IP 01 FC:0021

ASSIGNMENT

For good and valuable consideration, I, Maksim Kuzmenka, residing at Stockerweg 17, 81829, Munchen, Germany, and Oliver Kiehl, residing at 401 Ten Stones, Charlotte, Vermont, 05445, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at St. Martin Str. 53, 81669, Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on January 20, 2004 US. Serial No. 10/759,103,

entitled: **BUFFER AMPLIFIER ARCHITECTURE FOR SEMICONDUCTOR MEMORY CIRCUITS**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:  DATE: 19 May 2004
Maksim KUZMENKA: (1st INVENTOR)

SIGNATURE: _____ DATE: _____
Oliver KIEHL: (2nd INVENTOR)

ASSIGNMENT

For good and valuable consideration, I, Maksim Kuzmenka, residing at Stockerweg 17, 81829, Munchen, Germany, and Oliver Kiehl, residing at 401 Ten Stones, Charlotte, Vermont, 05445, hereinafter individually or collectively referred to as "Assignor";

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Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: _____ DATE: _____
Maksim KUZMENKA: (1st INVENTOR)

SIGNATURE: *Oliver Kiehl* DATE: May 20th 2004
Oliver KIEHL: (2nd INVENTOR)